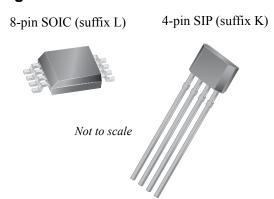


Dual Channel Hall Effect Direction Detection Sensor

Features and Benefits

- Precisely aligned dual Hall elements
- Tightly matched magnetic switchpoints
- Speed and direction outputs
- Individual Hall element outputs (L package)
- Fast power-on time
- Output short circuit protection
- Operation from an unregulated power supply
- Wide operating temperature range
- Wide operating voltage range
- Integrated EMC-ESD protection

Packages



Description

The A3423 is a dual-channel Hall-effect sensor ideal for use in speed and direction sensing applications incorporating encoder ring-magnet targets. The A3423 provides various output signals that indicate speed and direction of target rotation. The Hall elements are both photolithographically aligned to better than 1 μm . Maintaining accurate displacement between the two active Hall elements eliminates the major manufacturing hurdle encountered in fine-pitch detection applications. The sensors are highly sensitive, temperature-stable magnetic sensors ideal for use in harsh automotive and industrial environments.

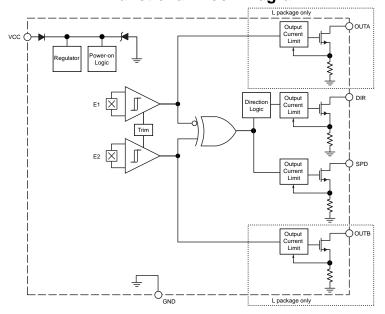
The Hall elements of the A3423 are spaced 1.63 mm apart, which provides excellent speed and direction information for small-geometry targets. Extremely low-drift amplifiers guarantee symmetry between the switches to maintain signal quadrature. An on-chip regulator allows the use of this device over a wide operating voltage range of 3.8 to 24 V.

End-of-line trimming of the Hall element switchpoints provides tight matching capability. The continuous-time nature of the Hall elements delivers a fast start-up of the sensor and low noise.

The A3423 has integrated protection against transients on the supply and output pins and short-circuit protection on all outputs.

The A3423 is available in a 4-pin SIP and a plastic 8-pin SOIC surface mount package (the SOIC version is currently in development). Both packages are lead (Pb) free, with 100% matte tin leadframe plating.

Functional Block Diagram



Dual Channel Hall Effect Direction Detection Sensor

Selection Guide

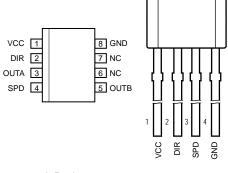
- Coloculari - Cultura					
Part Number	Package	Packing ¹	T _A (°C)		
A3423EK-T	4-pin through hole SIP	Bulk bag, 500 pieces/bag	-40 to 85		
A3423ELTR-T	8-pin surface mount SOIC ²	Tape and reel, 3000 pieces/reel	-4 0 t0 65		
A3423LK-T	4-pin through hole SIP	Bulk bag, 500 pieces/bag	-40 to 150		
A3423LLTR-T	8-pin surface mount SOIC ²	Tape and reel, 3000 pieces/reel	-4 0 to 150		



Absolute Maximum Ratings

Characteristic	Symbol	Notes	Rating	Units	
Supply Voltage	V _{CC}	-40°C to 150°C	30	V	
Reverse Battery Voltage	V _{RB}		-30	V	
Output Off Voltage	V _{OUT}		V _{cc}	V	
Output Sink Current	I _{OUT(SINK)}		30	mA	
Magnetic Flux Density	В		Unlimited	G	
On another Architect Terror and the	T _A	Range E	-40 to 85	°C	
Operating Ambient Temperature		Range L	-40 to 150	°C	
Storage Temperature	T _{stg}		-65 to 165	°C	
Maximum Junction Temperature	T _J (max)		165	°C	

Pin-out Diagrams



L Package K Package

Terminal List Table

Number		Name	Description				
K	L	IVallie	Description				
1	1	VCC	Input power supply; tie to GND with bypass capacitor				
2	2	DIR	Output signal indicating direction of target movement				
_	3	OUTA	Analog output indicating B at E1 Hall element				
3	4	SPD	Output signal indicating speed of target movement				
_	5	OUTB	Analog output indicating B at E2 Hall element				
_	6, 7	NC	No connection				
4	8	GND	Ground connection				



¹Contact Allegro for additional packing options.

²SOIC package currently in development.

A3423

Dual Channel Hall Effect Direction Detection Sensor

OPERATING CHARACTERISTICS valid at $T_A = -40^{\circ}\text{C}$ to 150°C, $T_J \le T_J$ (max), through full operating air gap range, unless otherwise noted

Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Electrical Characteristics	•			•	•	
Supply Voltage	V _{CC}	Operating, T _J ≤ 165°C	3.8	_	24	V
Output Leakage Current	I _{OFF}	All outputs V _{OUT} ≤ V _{CC} (max)	_	<1	10	μΑ
Undervoltage Lockout	V _{CC(UV)}		_	_	3.7	V
Undervoltage Hysteresis	V _{CC(hys)}	Lockout (V _{CC(UV)}) – Shutdown	_	0.4	_	V
Output Rise Time	t _r	C_{LOAD} = 20 pF, R_{LOAD} = 1 k Ω	_	200	_	ns
Output Fall Time	t _f	C_{LOAD} = 20 pF, R_{LOAD} = 1 k Ω	_	300	_	ns
Supply Current	I _{CC}		3.4	8.2	14	mA
Low Output Voltage	V _{sat}	All outputs; $I_{OUT} = 15 \text{ mA}$; $B > B_{OP(A)}$, $B > B_{OP(B)}$	_	210	500	mV
Output Current Limit	I _{OM}	All outputs	30	_	60	mA
Speed Output Delay*	t _d	Delay between direction changing and speed output transition	0.5	2.5	5	μs
Power-on Time	t _{ON}	B > B _{OP} + 5 G	_	2	5	μs
Transient Protection Characteristics	•				•	
Supply Zener Voltage	V _{Z(sup)}	I _{CC} = 17 mA, T _A = 25°C	30	_	_	V
Output Zener Voltage	V _{Z(out)}	I _{OUT} = 3 mA, T _A = 25°C	30	_	_	V
Supply Zener Current	I _{Z(sup)}	V _{supply} = 30 V, T _A = 25°C	_	_	17	mA
Output Zener Current	I _{Z(out)}	V _{OUT} = 30 V, T _A = 25°C	_	_	3	mA
Reverse Battery Current	I _{RCC}	V _{RCC} = -28 V, T _A = 25°C	_	_	15	mA
Magnetic Characteristics			•			•
Operate Point (Channel A and Channel B)	B _{OP}	$B_{(A)} > B_{OP(A)}, B_{(B)} > B_{OP(B)}$	-35	15	55	G
Release Point (Channel A and Channel B)	B _{RP}	$B_{(A)} < B_{OP(A)}, B_{(B)} < B_{OP(B)}$	-55	-15	35	G
Hysteresis (Channel A and Channel B)	B _{hys}	B _{OP} – B _{RP}	10	30	60	G
Operate Symmetry	SYM _{OP(AB)}	$B_{OP(A)} - B_{OP(B)}$	-50	_	50	G
Release Symmetry	SYM _{RP(AB)}		-50	_	50	G

^{*} Valid only after the first speed (SPD pin) signal transition. First speed signal transition has no delay.

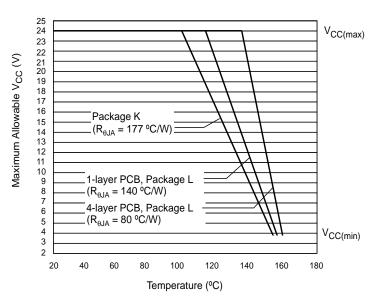


THERMAL CHARACTERISTICS may require derating at maximum conditions, see application information

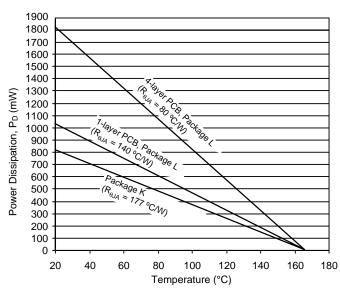
Characteristic	Symbol	Test Conditions*		Units
Package Thermal Resistance	$R_{ heta JA}$	Package K, 1-layer PCB with copper limited to solder pads	177	°C/W
		Package L, 1-layer PCB with copper limited to solder pads	140	°C/W
		Package L, 4-layer PCB	80	°C/W

^{*}Additional thermal information available on Allegro website.

Power Derating Curve

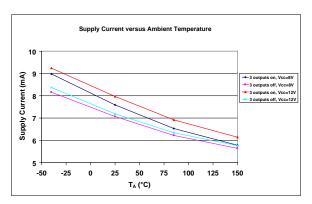


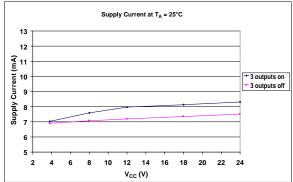
Power Dissipation versus Ambient Temperature

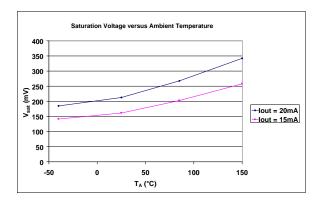


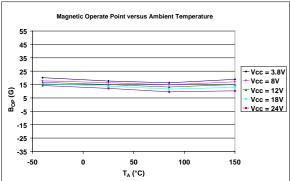


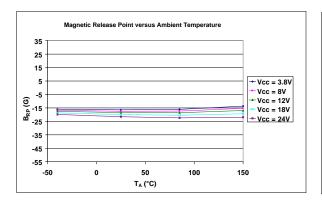
Performance Characteristics

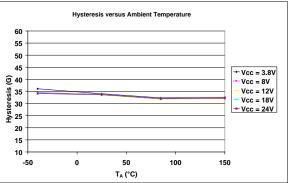












Functional Description

The integrated circuit contains an internal voltage regulator that powers the Hall sensors and both the analog and digital circuitry. This regulator allows operation over a wide supply voltage range and provides some immunity to supply noise. The device also contains logic circuitry that decodes the direction of rotation of the ring magnet.

Quadrature/Direction Detection Internal logic circuitry provides outputs representing the speed and direction of the magnetic field across the face of the package. For the direction signal to be appropriately updated, a quadrature relationship must be maintained between the target magnetic pole width, the pitch between the two Hall elements (E1 and E2) in the sensor, and, to a lesser extent, the magnetic switchpoints.

For optimal design, the sensor should be actuated by a ring magnet that presents to the front of the sensor a field with a pole width two times the Hall element-to-element spacing. This will produce a sinusoidal magnetic field whose period (denoted as *T*) is then four times the element-to-element spacing. A quadrature relationship can also be maintained for a ring magnet with fields having a period that satisfies the relationship:

$$nT/4 = 1.63 \text{ mm}$$

where n is any odd integer. Therefore, ring magnets with polepair spacing equal to 6.52 mm (n = 1), 2.17 mm (n = 3), 1.3 mm (n = 5), and so forth, are permitted.

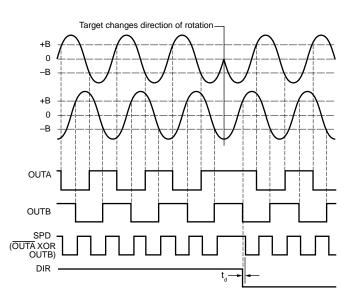


Figure 1

The response of the device to the magnetic field produced by a rotating ring magnet is shown in the Performance Characteristics section. Note the phase shift between the two integrated Hall elements.

Outputs The device provides up to four saturated outputs: target direction (DIR pin), E1 sensor output (OUTA pin), E2 sensor output (OUTB pin), and target speed (SPD pin).

DIR provides the direction output of the sensor and is defined as off (high) for targets moving in the direction from E1 to E2 and on (low) for the direction E2 to E1. SPD provides an XORed output of the two Hall elements (see figure 1). Because of internal delays, DIR is always updated before SPD and is updated at every transition of OUTA and OUTB (internal) allowing the use of up-down counters without the loss of pulses.

Power-on State At power on, the logic circuitry is reset to provide an off (high) state for all the outputs. If any of the channels is subjected to a field greater than B_{OP} , the internal logic will set accordingly, and the outputs will switch to the expected state.

Power-on Time This characteristic, t_{ON} , is the elapsed time from when the supply voltage reaches the device supply minimum until the device output becomes valid (see figure 2).

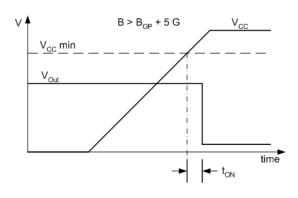


Figure 2



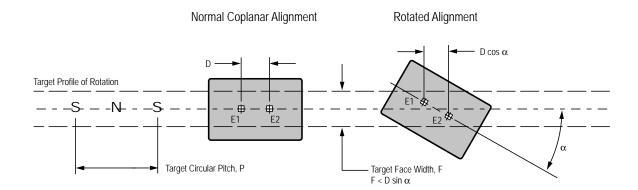
Application Information

Operation with Fine-Pitch Ring Magnets. For targets with a circular pitch of less than 4 mm, a performance improvement can be observed by rotating the front face of the sensor subassembly (see below). This sensor rotation decreases the effective Hall element-to-element spacing, provided that the Hall elements are not rotated beyond the width of the target.

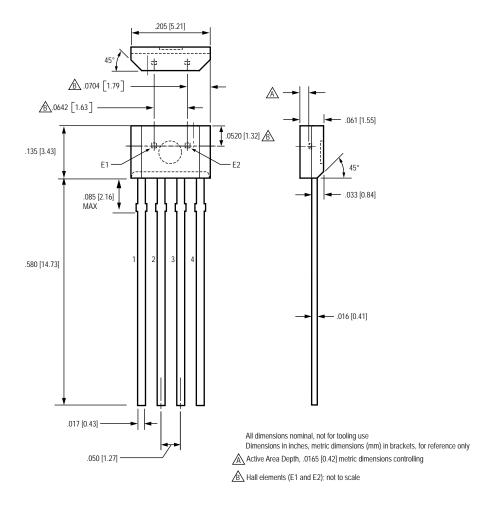
Applications. It is strongly recommended that an external 0.01 μ F bypass capacitor be connected (in close proximity to the Hall sensor) between the supply and ground of the device to

reduce both external noise and noise generated by the internal logic.

The simplest form of magnet that will operate these devices is a ring magnet. Other methods of operation, such as linear magnets, are possible. Extensive applications information on magnets and Hall-effect sensors is also available in the "Hall-Effect IC Applications Guide" which can be found in the latest issue of Application Note 27701, at www.allegromicro.com/techpub2/an/an27701.pdf.

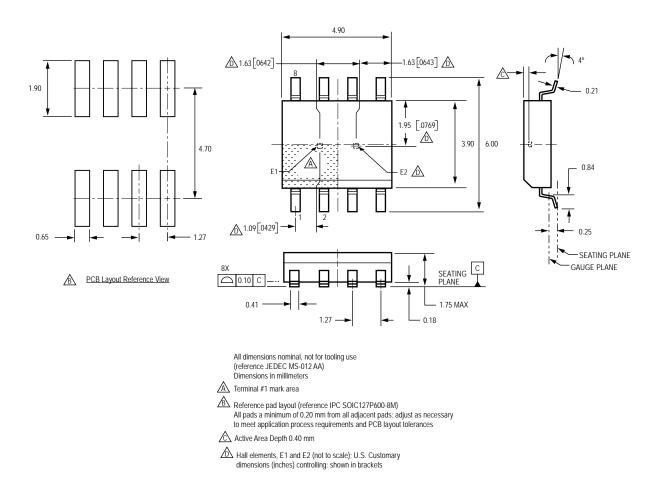


Package K, 4-Pin SIP





Package L, 8-Pin SOIC



Copyright ©2007-2008, Allegro MicroSystems, Inc.

The products described herein are manufactured under one or more of the following U.S. patents: 5,045,920; 5,264,783; 5,442,283; 5,389,889; 5,581,179; 5,517,112; 5,619,137; 5,621,319; 5,650,719; 5,686,894; 5,694,038; 5,729,130; 5,917,320; and other patents pending.

Allegro MicroSystems, Inc. reserves the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the performance, reliability, or manufacturability of its products. Before placing an order, the user is cautioned to verify that the information being relied upon is current.

Allegro's products are not to be used in life support devices or systems, if a failure of an Allegro product can reasonably be expected to cause the failure of that life support device or system, or to affect the safety or effectiveness of that device or system.

The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems, Inc. assumes no responsibility for its use; nor for any infringement of patents or other rights of third parties which may result from its use.

> For the latest version of this document, visit our website: www.allegromicro.com

